

LIST OF PUBLICATIONS CITED BY APPLICANT	<u>Attorney Docket No.</u> SEL 238	<u>Serial No.</u> Not Assigned
	<u>Applicant</u> Masaaki HIROKI et al	
	<u>Filing Date</u> Herewith	<u>Group</u>

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 09/776474
 02/02/01

U.S. PATENT DOCUMENTS

*EXAMINER INITIAL	DOCUMENT NUMBER	DATE	NAME	CLASS	SUB- CLASS	FILING DATE
<i>MBC</i>	5,247,190	09/21/93	Friend et al	257	40	12/28/90
<i>MBC</i>	5,399,502	03/21/95	Friend et al	437	1	05/05/93

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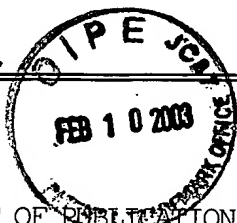
	DOCUMENT NUMBER	DATE	NAME	CLASS	SUB- CLASS	FILING DATE
<i>MBC</i>	WO 90/13148	11/01/90	Cambridge Research and Innovation, Ltd.			04/18/90
<i>MBC</i>	JP 10-092576	04/10/98	Cambridge Display Technology, Ltd.			04/18/97

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<i>MBC</i>	1) Shenk, H. et al, "Polymers for Light Emitting Diodes," EuroDisplay '99, Proceedings of the 19th International Display Research Conference, Berlin, Germany, September 6-9, 1999, pp. 33-37.
<i>MBC</i>	2) English abstract re Japanese Patent Application No. 10-092576, published April 10, 1998.

EXAMINER: <i>MBC</i>	DATE CONSIDERED: 2/25/03
*EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP form. Draw line through citation if not in conformance and not considered. Include a copy of this form with the next communication to applicant.	



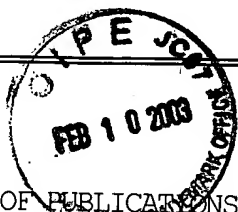
LIST OF PUBLICATIONS/MATERIALS CITED BY APPLICANT	<u>Attorney Docket No.</u> SEL 238	<u>Serial No.</u> 09/776,472
	<u>Applicant</u> Hiroki et al.	RECEIVED FEB 11 2003 TC 1700
	<u>Filing Date</u> February 2, 2001	

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*EXAMINER INITIAL	DOCUMENT NUMBER	DATE	NAME	CLASS	SUB- CLASS	FILING DATE
MBC	5,817,366	10/06/98	Arai et al.			7/29/96
MBC	5,714,195	2/03/98	Shiba et al.			3/29/95
MBC	6,013,982	1/11/00	Thompson et al.			12/23/96
MBC	4,067,020	1/03/78	Arway			9/20/76
MBC	6,394,578	5/28/02	Akahira et al.			8/31/99

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MBC	EP 0 859 539	8/19/98	Onitsuka et al.			2/16/98
MBC	EP 1 093 167	4/18/01	Yamazaki et al.			10/12/00
MBC	EP 0 880 303	11/25/98	Miyashita et al.			11/25/97
MBC	EP 0 892 028	1/20/99	Kiguchi et al.			7/14/98

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msc	6,134,020	10/17/00	Masumoto et al.			11/17/97

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	JP 11 054270	2/26/99	Kiguchi et al.			7/30/97
	JP 10 092576	4/10/98	Friend et al.			4/18/97
	JP 10 153967	6/09/98	Miyashita et al.			11/25/96
	JP 10 012377	1/16/98	Shimoda et al.			6/19/96
	JP 10 189252	7/21/98	Hosokawa			12/26/96

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	DOCUMENT NUMBER	DATE	NAME	CLASS	SUB- CLASS	FILING DATE
<i>M30</i>	WO 99 21233	4/29/99	Yang			10/14/98
	JP 11 025852	1/29/99	Hasegawa et al.			5/07/98
<i>M10</i>	UK 2,336,553	10/27/99	Lacey et al.			4/23/99

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MBO	6,274,887	8/14/01	Yamazaki et al.			11/01/99

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MBO	EP 0 683 406	11/22/95	Kashiwazaki et al.			5/19/95
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947P	European Search Report for Reference EP 19819-011/we
MBO	US Patent Application No. 09/685,698 to Yamazaki et al., including copies of specification, claims, abstract, drawings and PTO filing receipt.
MBO	US Patent Application No. 09/685,912 to Yamazaki et al., including copies of specification, claims, abstract, drawings and PTO filing receipt.

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